

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

ltc1329is8-50#trpbf

(Engineering Calculation)

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(printed on: 2020-07-11 18:08:02)

**TOTAL MASS (g) : 0.073601**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.002200	1000000	29890.9589844		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.023653	975000	321368.5625		
		Iron (Fe)	7439-89-6	0.000582	24000	7907.51708984		
		Phosphorus (P)	7723-14-0	0.000007	300	95.1075973511		
		Zinc (Zn)	7440-66-6	0.000017	700	230.975601196		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.024259</b>	<b>1000000</b>	<b>329602.15625</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.001477	1000000	20065.6914062		
		<b>External Plating Total:</b>				<b>0.001477</b>	<b>1000000</b>	<b>20065.6914062</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000194	1000000	2635.83886719		
<b>Internal Plating Total:</b>				<b>0.000194</b>	<b>1000000</b>	<b>2635.83886719</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000736	750000	9999.88476562		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000245	250000	3328.76586914		
<b>Die Attach Total:</b>				<b>0.000981</b>	<b>1000000</b>	<b>13328.6503906</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.006657	150000	90447.328125		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.036392	820000	494450.8125		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.001110	25000	15081.3466797		
		Carbon Black (C)	1333-86-4	0.000222	5000	3016.26953125		
		<b>Encapsulation Total:</b>				<b>0.044381</b>	<b>1000000</b>	<b>602995.75</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000109	1000000	1480.96105957		
					<b>TOTAL MASS (g) :</b>	<b>0.073601</b>		